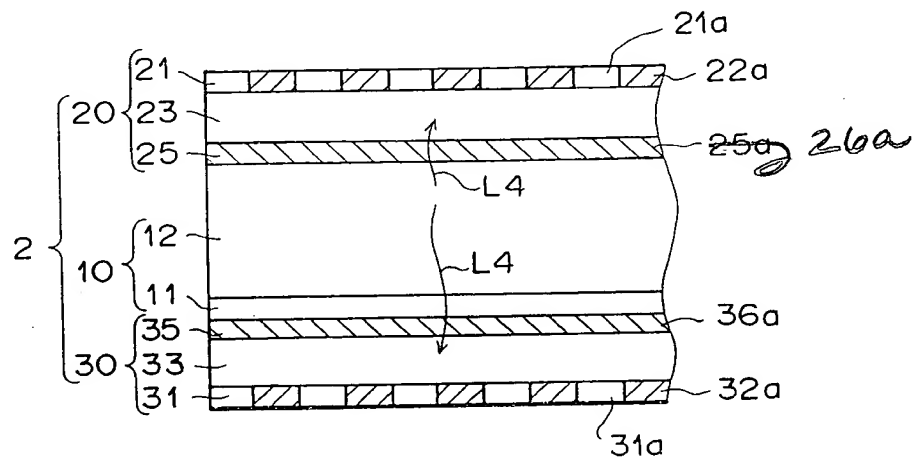
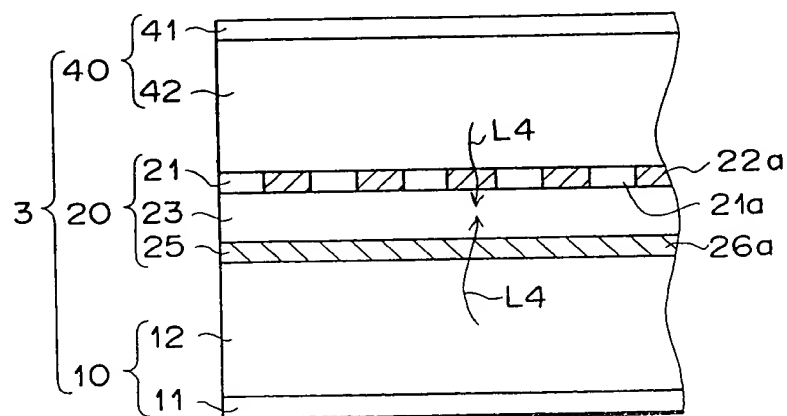




F I G . 6



F I G . 7



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FIG. 8A

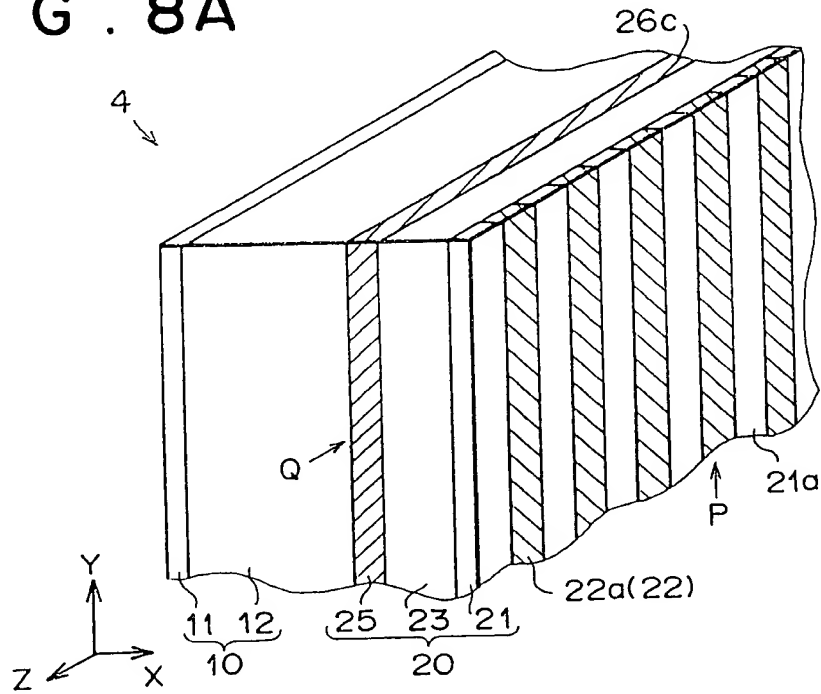


FIG. 8B

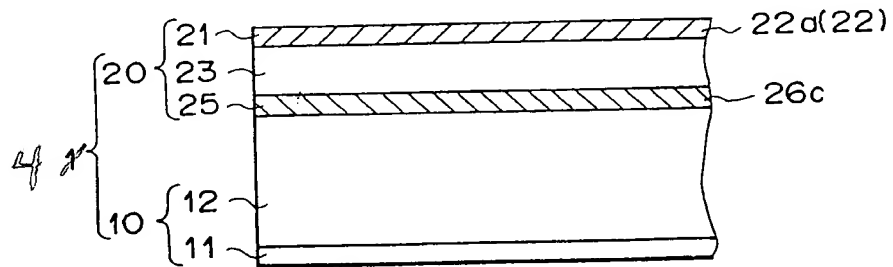
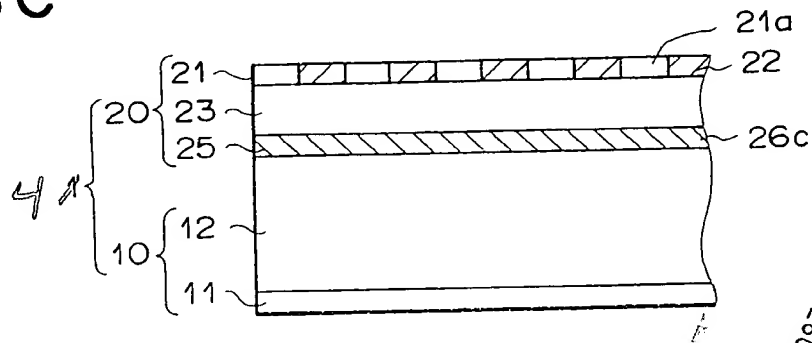


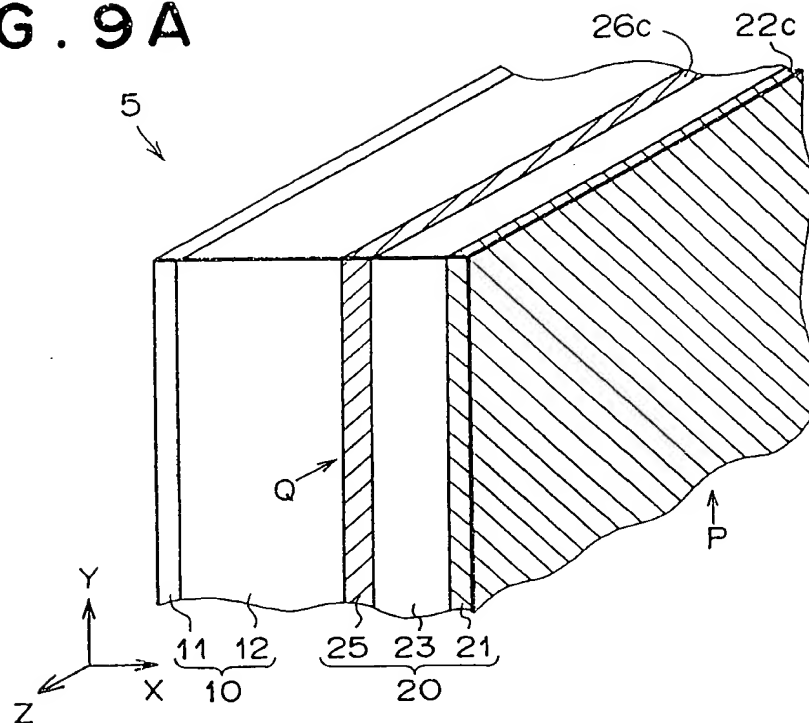
FIG. 8C



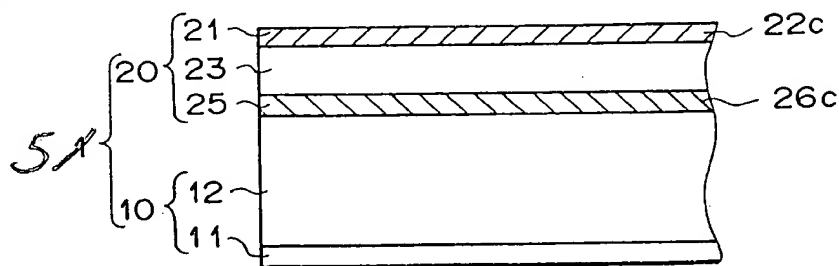
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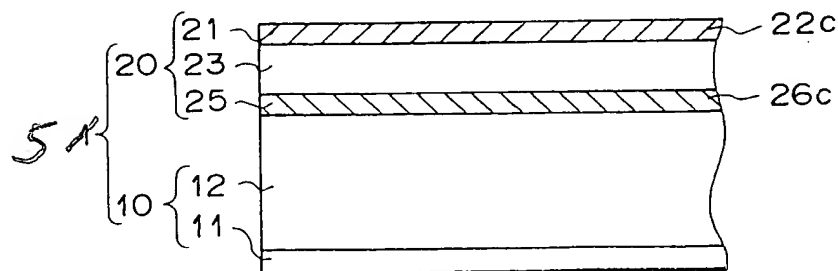
F I G . 9 A



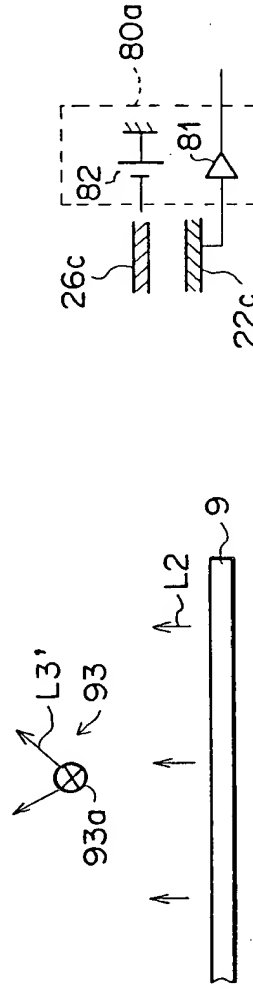
F I G . 9 B



F I G . 9 C



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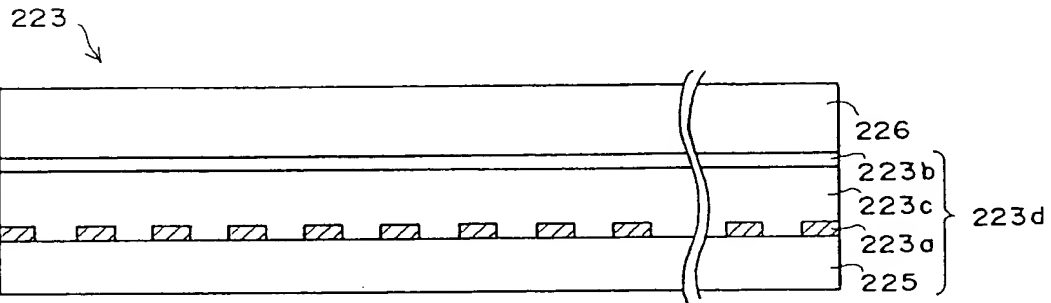


F I G . 10

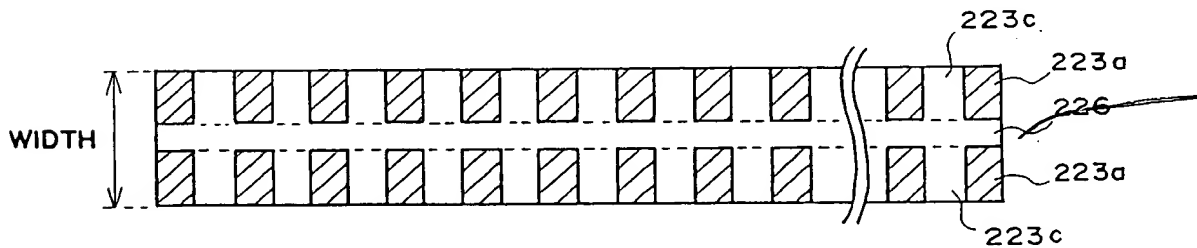
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F I G . 17A



F I G . 17B



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FIG. 18A

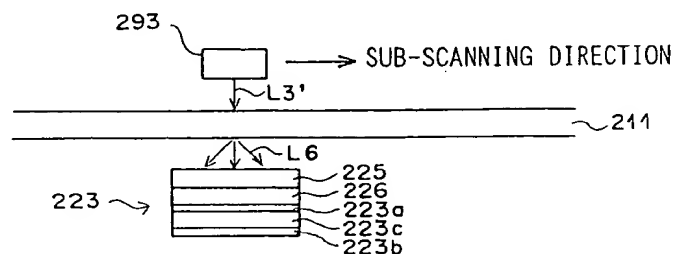


FIG. 18B

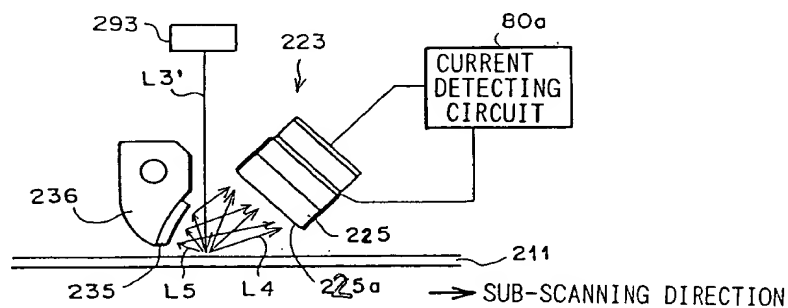


FIG. 18C

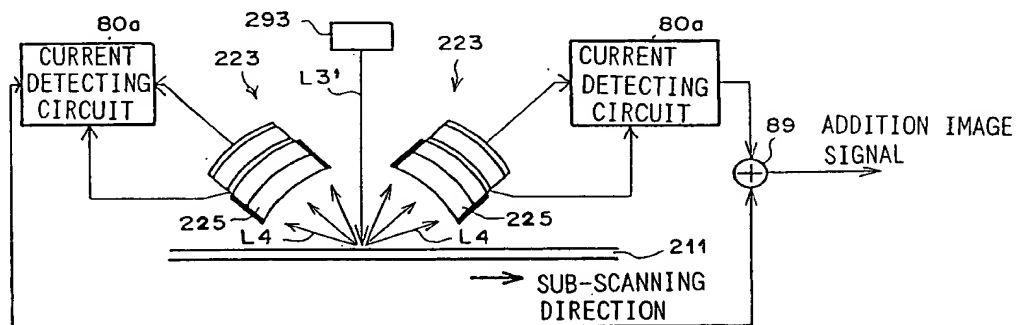
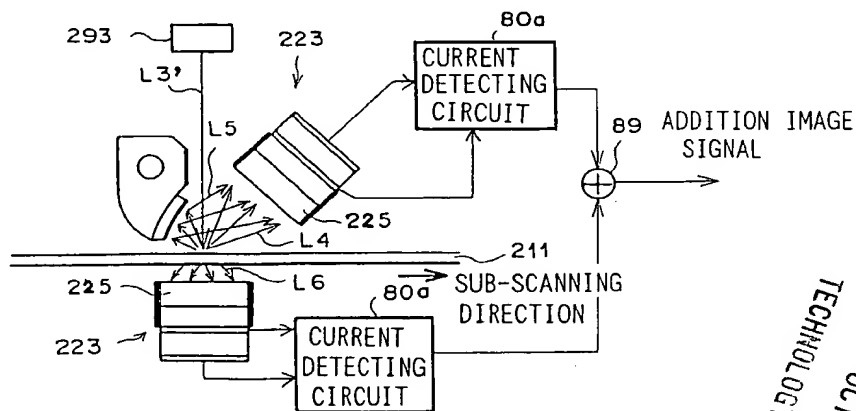


FIG. 18D



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